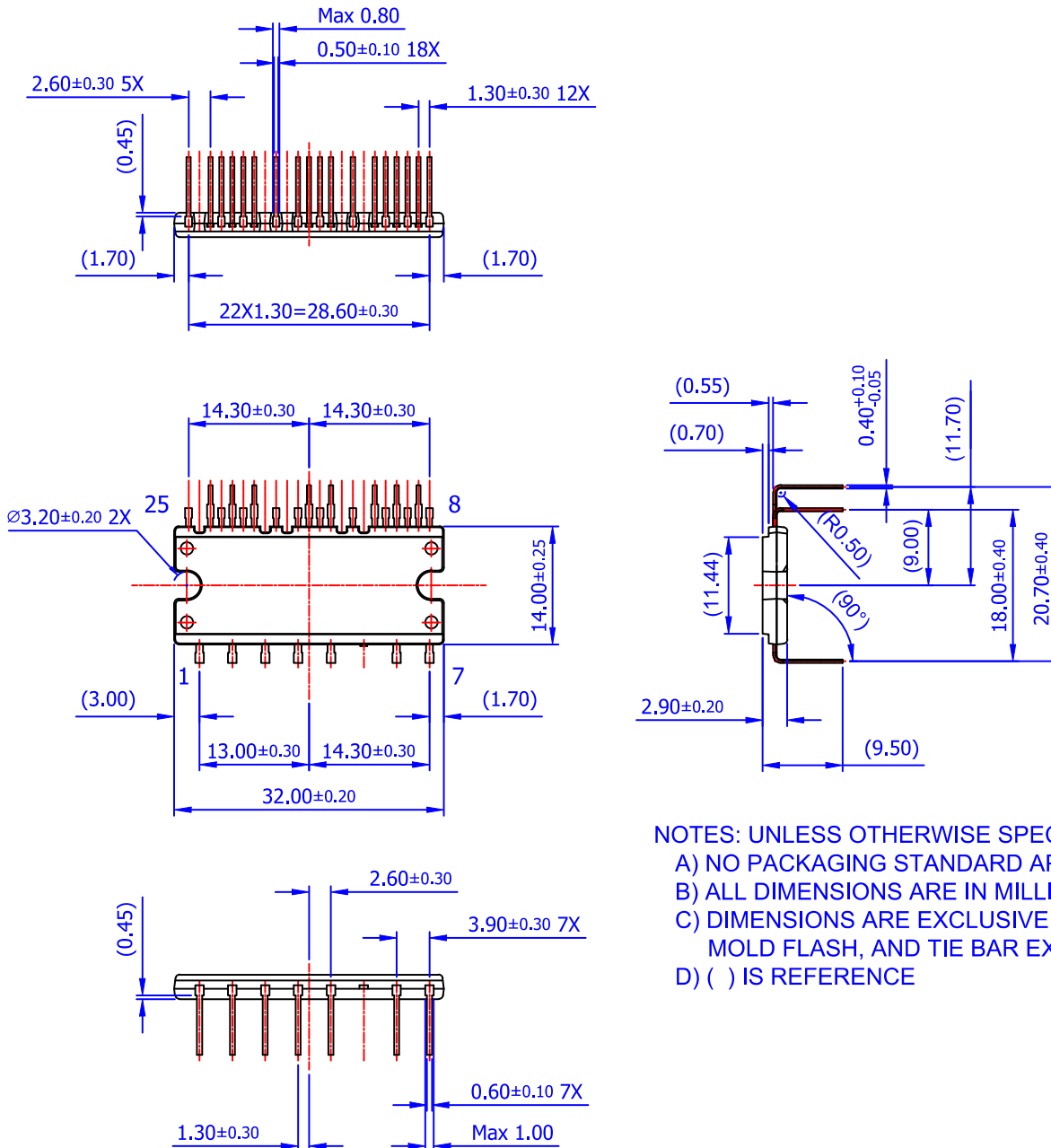


SPMFA-A25 / 25LD, FULL PACK, DIP TYPE, SPM8 SERIES
CASE MODEZ
ISSUE O

DATE 31 JAN 2017



NOTES: UNLESS OTHERWISE SPECIFIED
A) NO PACKAGING STANDARD APPLIES
B) ALL DIMENSIONS ARE IN MILLIMETERS
C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
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